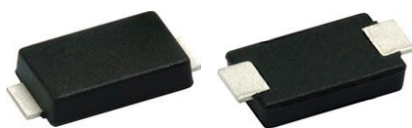


Surface Mount PAR[®] Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions

eSMP[®] Series



Top View

Bottom View

SlimSMA (DO-221AC)

Cathode  Anode

DESIGN SUPPORT TOOLS

[click logo to get started](#)

3D
Models
Available

PRIMARY CHARACTERISTICS

V_{BR}	6.8 V to 51 V
V_{WM}	5.8 V to 43.6 V
P_{PPM} (10 x 1000 μ s)	600 W
P_D at $T_M = 65^\circ\text{C}$	6 W
T_J max.	185 $^\circ\text{C}$
Polarity	Uni-directional
Package	SlimSMA (DO-221AC)

FEATURES

- Very low profile - typical height of 0.95 mm
- Junction passivation optimized design passivated anisotropic rectifier technology
- $T_J = 185^\circ\text{C}$ capability suitable for high reliability and automotive requirement
- Ideal for automated placement
- Uni-directional only
- Excellent clamping capability
- Peak pulse power: 600 W (10/1000 μ s)
- AEC-Q101 qualified
- ESD capability: IEC 61000-4-2 level 4
 - 15 kV (air)
 - 8 kV (contact)
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 $^\circ\text{C}$
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units for consumer, computer, industrial, and telecommunication.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating
Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B,.....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power dissipation with a 10/1000 μ s waveform	P_{PPM} ⁽¹⁾	600	W
Peak pulse current with a 10/1000 μ s waveform	I_{PPM} ⁽¹⁾	See next table	A
Power dissipation on infinite heat sink, $T_M = 65^\circ\text{C}$	P_D ⁽²⁾	6	W
Power dissipation, $T_M = 25^\circ\text{C}$	P_D ⁽³⁾	1.1	
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +185	$^\circ\text{C}$

Notes

⁽¹⁾ Non-repetitive current pulse, per fig. 3 and derated above $T_A = 25^\circ\text{C}$ per fig. 2.

⁽²⁾ Power dissipation mounted on infinite heat sink

⁽³⁾ Power dissipation mounted on minimum recommended pad layout

**ELECTRICAL CHARACTERISTICS** ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE $V_{BR}^{(1)}$ AT I_T (V)		TEST CURRENT I_T (mA)	STAND-OFF VOLTAGE V_{WM} (V)	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_R (μA)	$T_J = 150\text{ }^{\circ}\text{C}$ MAXIMUM REVERSE LEAKAGE AT V_{WM} I_R (μA)	MAXIMUM PEAK PULSE SURGE CURRENT I_{PPM} (A)	MAXIMUM CLAMPING VOLTAGE AT I_{PPM} V_C (V)
		MIN.	MAX.						
TA6F6.8A	AEP	6.45	7.14	10	5.80	500	1000	57.1	10.5
TA6F7.5A	AGP	7.13	7.88	10	6.40	250	500	53.1	11.3
TA6F8.2A	AKP	7.79	8.61	10	7.02	100	200	49.6	12.1
TA6F9.1A	AMP	8.65	9.55	1.0	7.78	25	50	44.8	13.4
TA6F10A	APP	9.5	10.5	1.0	8.55	5.0	20	41.4	14.5
TA6F11A	ARP	10.5	11.6	1.0	9.40	2.0	5.0	38.5	15.6
TA6F12A	ATP	11.4	12.6	1.0	10.2	2.0	5.0	35.9	16.7
TA6F13A	AVP	12.4	13.7	1.0	11.1	2.0	5.0	33.0	18.2
TA6F15A	AXP	14.3	15.8	1.0	12.8	1.0	5.0	28.3	21.2
TA6F16A	AZP	15.2	16.8	1.0	13.6	1.0	5.0	26.7	22.5
TA6F18A	BEP	17.1	18.9	1.0	15.3	1.0	5.0	23.5	25.5
TA6F20A	BGP	19.0	21.0	1.0	17.1	1.0	5.0	21.7	27.7
TA6F22A	BKP	20.9	23.1	1.0	18.8	1.0	5.0	19.6	30.6
TA6F24A	BMP	22.8	25.2	1.0	20.5	1.0	5.0	18.1	33.2
TA6F27A	BPP	25.7	28.4	1.0	23.1	1.0	5.0	16.0	37.5
TA6F30A	BRP	28.5	31.5	1.0	25.6	1.0	5.0	14.5	41.4
TA6F33A	BTP	31.4	34.7	1.0	28.2	1.0	5.0	13.1	45.7
TA6F36A	BVP	34.2	37.8	1.0	30.8	1.0	5.0	12.0	49.9
TA6F39A	BXP	37.1	41.0	1.0	33.3	1.0	5.0	11.1	53.9
TA6F43A	BZP	40.9	45.2	1.0	36.8	1.0	10.0	10.1	59.3
TA6F47A	CEP	44.7	49.4	1.0	40.2	1.0	10.0	9.3	64.8
TA6F51A	CGP	48.5	53.6	1.0	43.6	1.0	10.0	8.6	70.1

Note(1) Pulse test: $t_p \leq 50\text{ ms}$ **THERMAL CHARACTERISTICS** ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Typical thermal resistance, junction to ambient	$R_{\theta JA}^{(1)}$	145	$^{\circ}\text{C/W}$
Typical thermal resistance, junction to mount	$R_{\theta JM}^{(2)}$	20	$^{\circ}\text{C/W}$

Notes

(1) Mounted on minimum recommended pad layout

(2) Mounted on infinite heat sink

IMMUNITY TO STATIC ELECTRICAL DISCHARGE TO THE FOLLOWING STANDARDS($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
IEC 61000-4-2	Human body model (contact mode)	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$	V_C	4	$> 8\text{ kV}$
	Human body model (air discharge mode)				$> 15\text{ kV}$

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TA6F6.8AHM3_A/H ⁽¹⁾	0.032	H	3500	7" diameter plastic tape and reel
TA6F6.8AHM3_A/I ⁽¹⁾	0.032	I	14 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

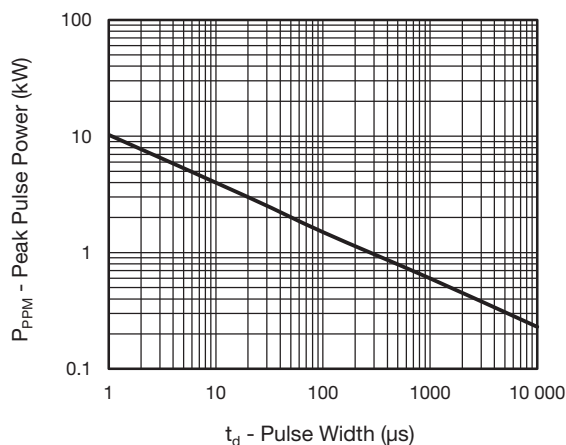


Fig. 1 - Peak Pulse Power Rating Curve

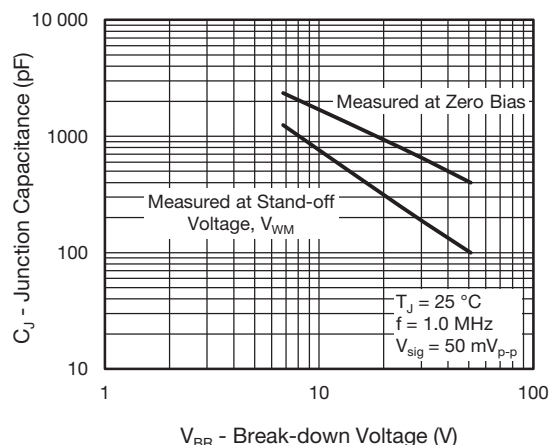


Fig. 4 - Typical Junction Capacitance

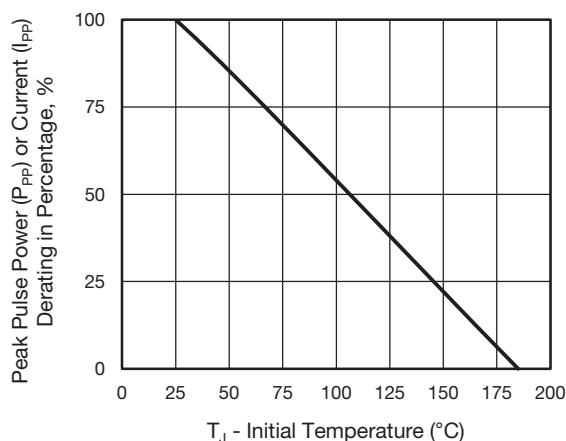


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

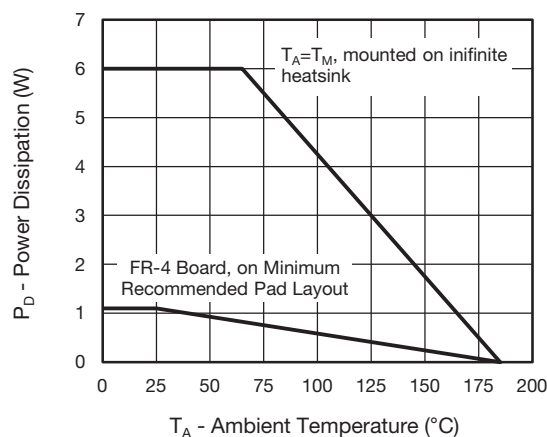


Fig. 5 - Power Dissipation Derating Curve

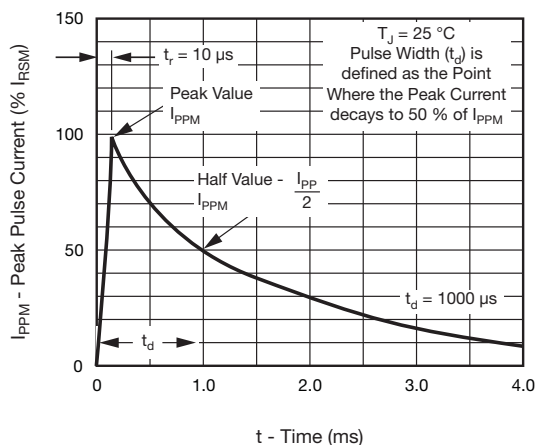


Fig. 3 - Pulse Waveform

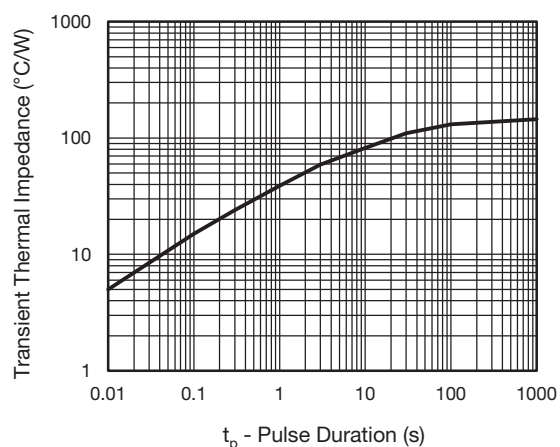
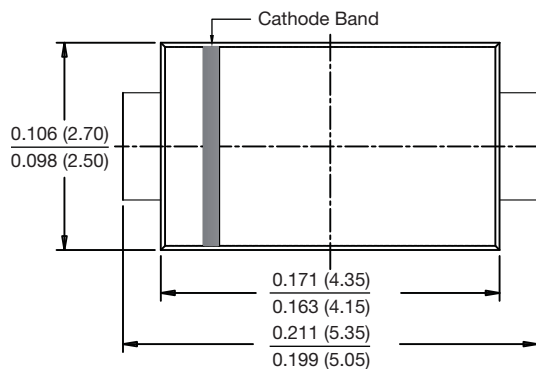


Fig. 6 - Typical Transient Thermal Impedance

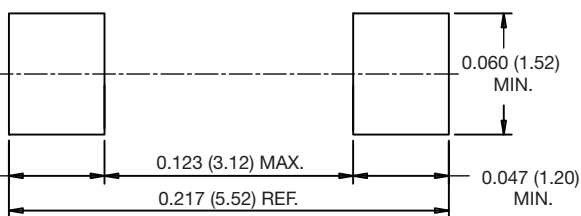
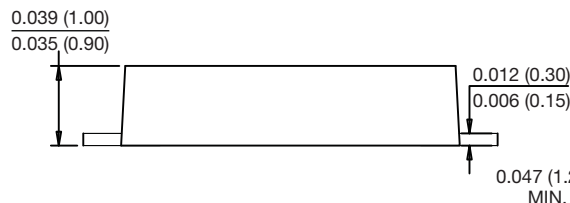


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)



Mounting Pad Layout





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